



Improved surface quality and hygrothermal performance of epoxy based prepreg by liquefied dicyandiamide with enhanced solubility and dispersibility



Gang Li ^{a,b,*}, Bo Li ^a, Yibin Liu ^a, Dawei Liu ^a, Xiaoping Yang ^a

^a State Key Laboratory of Organic-Inorganic Composites, Beijing University of Chemical Technology, Beijing 100029, PR China

^b Changzhou Institute of Advanced Materials, Beijing University of Chemical Technology, Beijing 100029, PR China

ARTICLE INFO

Article history:

Received 14 January 2016

Received in revised form 5 April 2016

Accepted 9 April 2016

Available online 13 April 2016

Keywords:

Epoxy

Dicyandiamide

Prepreg

Surface quality

Hygrothermal property

ABSTRACT

Liquefied dicyandiamide (L-DICY) was fabricated by pretreatment of DICY with polyetheramine (PEA)/diglycidyl ether of bisphenol A (DGEBA) adduct, and physicochemical properties of L-DICY, mechanical, thermal and optical properties of L-DICY cured epoxy resins and hygrothermal performance of L-DICY cured epoxy based prepregs were evaluated to compare with those of DICY and PEA/DICY blends. Amine hydrogen equivalent weight of L-DICY was increased with inferior reactivity to PEA/DICY. The solubility of PEA/DICY and L-DICY in epoxy resin was increased due to good dissolving ability of PEA and PEA/DGEBA adduct. The dispersibility of PEA/DICY and L-DICY in epoxy resins was improved, while dispersion stability of L-DICY was superior to that of PEA/DICY. The mechanical and thermal properties of three kinds of resin matrix changed little, while transparency of L-DICY cured resin films was higher than those of DICY and PEA/DICY. The surface qualities and hygrothermal properties of epoxy based prepreg composites were improved notably, which was attributed to DICY crystal reduction in cured resin films resulted from enhanced solubility and dispersibility of L-DICY.

© 2016 Elsevier Ltd. All rights reserved.

1. Introduction

Carbon fiber/epoxy prepregs as the intermediate-product of composites were widely used in large-scale components such as aerospace and automotive parts, which were mainly based on carbon fiber fabric impregnated by B-staged epoxy matrix [1–3]. Hot-melt impregnation was the prevalent method to prepare epoxy based prepregs, which consisted of applying a uniform resin film to a release paper and further impregnating the fiber bed by the upper and lower resin film with hot-pressing [4,5]. Therefore, the uniformity of surface appearance and curing behavior of resin films were one of the key indexes for prepreg quality control, which was dependent on the homogeneity of resin matrix made up of epoxy resin and curing system [6–8]. Dicyandiamide (DICY) was the most commonly used latent curing agent in intermediate temperature curing prepreg system [9,10]. However, the poor solubility of DICY in non-polar epoxy resin resulted in the tendency to separate and form a white precipitate on prepreg surface [7,11], and the sedimentation of DICY crystals would affect the degree of crosslinking as well as the hygrothermal properties of DICY cured composites [12, 13]. Generally, the chemical modification by molecular design or physical

dissolving by liquid curing agent was a feasible way to improve the solubility and compatibility between DICY and epoxy resin.

The reactivity and compatibility between epoxy resin and DICY chemically modified by aromatic or aliphatic amine have been much improved [14,15], but the higher reactivity led to the reduction of out time and shelf life of prepregs. DICY solution was obtained by dissolving it in a liquid multifunctional amine such as aliphatic amine [16], which possessed good dissolving ability and compatibility with epoxy resin. The solution could prevent crystal separation taking place during the impregnation of fiber fabrics and curing process of the impregnated prepregs. However, the combination of DICY and liquid aliphatic amine also increased the curing rate of resin mixture due to the high reactivity of aliphatic amine. In view of the high volatility and reactivity of aliphatic amine with low molecular weight, the aliphatic amine adducts of increased molecular chain have been developed by addition reaction between aliphatic amine and epoxide compound [17,18], which led to reduced reactivity, improved handling safety and surface appearance of epoxy resin films. Also, the soluble aliphatic amine adducts with amphiphilic structure could promote the solubility of DICY in epoxy resin, which was due to the favorable solvent environment (i.e., higher dielectric constant, hydrogen bonding) [19].

Therefore, to obtain well-balanced solubility and curing rate of modified DICY in epoxy resins, the adducts of polyetheramine (PEA) and diglycidyl ether of bisphenol A (DGEBA) were synthesized for preparing the liquefied DICY (L-DICY), and the reactivity and solubility of L-DICY

* Corresponding author at: State Key Laboratory of Organic-Inorganic Composites, Beijing University of Chemical Technology, Beijing 100029, PR China.

E-mail address: ligang@mail.buct.edu.cn (G. Li).

Download English Version:

<https://daneshyari.com/en/article/827977>

Download Persian Version:

<https://daneshyari.com/article/827977>

[Daneshyari.com](https://daneshyari.com)